



VULQ1-S/BEAMS series MULTIBEAM LASER MARKING SYSTEMS



VULQ1™ product offer overview

BETTER LASER SOLUTIONS FOR A BETTER MANUFACTURING

Laser is the production tool of the future. But the way laser solutions are designed today limits their performance. Conventional laser processing reaches 3 limits:

- Throughput limit: with high power laser available, throughput is limited by the speed of the laser beam onto the sample. This is particularly true for high resolution applications.
- Economical limit: adding to the processing time induced by throughput limit, it is frequent to use only part of the available laser power.
- Environmental limit: laser processing is intrinsically a green production tool, it will be even greener running at 100% of its capacity.

Multibeam laser processing with VULQ1 unlocks these three bottlenecks.

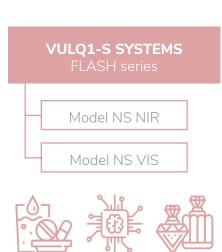
Multibeam processing is the combination of dynamic laser beam shaping with **VULQ1** and traditional laser beam delivery systems.

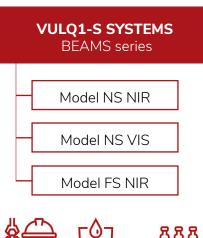
Powered by our patented programmable multibeam technology, VULQ1 accelerates laser processing manyfold compared to conventional laser marking.



















VULQ1-S / BEAMS accelerates laser processing throughput manyfold by combining scanning with dynamically programmable multibeam technology.

VULQ1-S / BEAMS is a stand-alone multibeam laser marking system, ready for integration into all production environments, production line or stand-alone machine.

VULQ1-S / BEAMS addresses an extended scope of applications thanks to their multiple operation modes: standard vectorial mode, multibeam mode, and our patented PIXEL-STAMP mode.

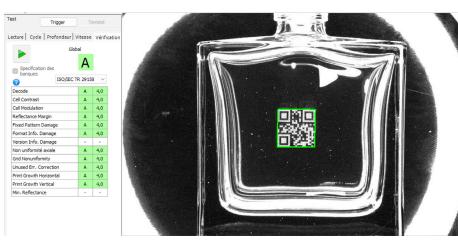
VULQ1-S / BEAMS laser systems are available in 1030 nm, 1064 nm, and 532 nm single wavelength, up to 72 W output power, and 6.4mJ pulse energy to deliver superior throughput.

MAIN APPLICATIONS

- High speed Datamatrix and QR codes marking on primary packaging
- High speed surface decoration and texturing
- High speed micro-drilling of thin layers

FEATURES

- Typical 3-10x cycle time reduction vs conventional laser marking
- Texturing down to micron level with cm²/s rate with PIXEL-STAMP marking patent
- Dynamically configurable beam shape and Z focus



More applications?

Check our website



www.qiova.com

Figure 1: A Grade QR code marking on glass with VULQ1-S BEAMS FS NIR. Marking Time = 2s

Product line	Model	Max energy	Max power	Pulse duration	Wavelength	Materials	Marking time
	NS NIR	6,4 mJ	64 W	ns	1064 nm	Metals, coated materials, polymers, molded compound	3-10x shorter ¹
VULQ1-S BEAM series	NS VIS	3,2 mJ	32 W	ns	532 nm	Polymers, films, multilayers, elastomers	3-10x shorter ¹
	FS NIR	720 µJ	72 W	ps-fs	1030-1064 ns	Ceramic, glass	3-10x shorter ¹

Figure 2: BEAMS series overview

¹ Marking time typically 3-10x shorter than conventional laser marking





Specifications

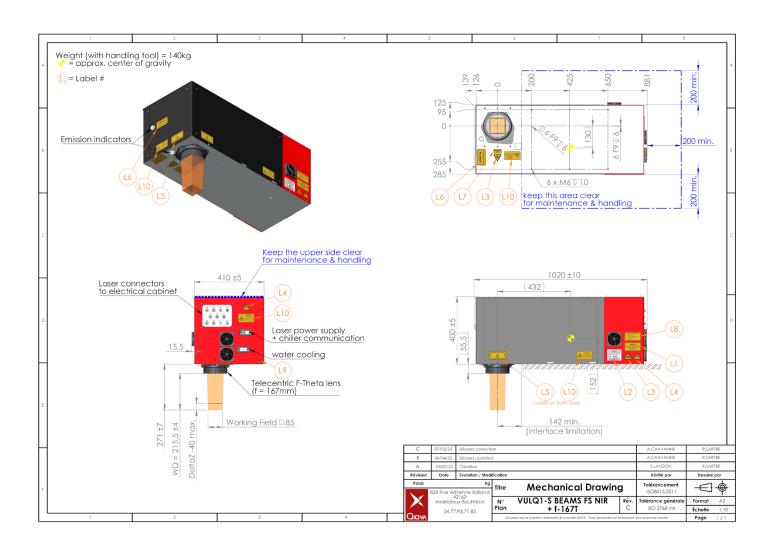
	Length	1000-1100 nm 72 W 250 fs 6.4 mJ 1 MHz F80, F160, F167 Telecentric 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO YES 1030 mm	500-550 nm 24 W 5 ns 3.2 mJ 100 kHz F80, F160 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO YES		
Wavelength Max power Min pulse duration Max pulse energy¹ Max Pulse Repetition Rate Optical output F-theta focal length Working distance range Max 3D scanning volume Modes of operation Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head	9	72 W 250 fs 6.4 mJ 1 MHz F80, F160, F167 Telecentric 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO YES	24 W 5 ns 3.2 mJ 100 kHz F80, F160 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO		
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Max Pulse Repetition Rate Optical output F-theta focal length Working distance range Max 3D scanning volume Modes of operation Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	1 MHz F80, F160, F167 Telecentric 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO YES	100 kHz F80, F160 80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO		
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F-theta focal length Working distance range Max 3D scanning volume Modes of operation Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO YES	80 - 220 mm 100 mm x 100 mm x 40 mm YES YES NO		
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Max 3D scanning volume Modes of operation Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	100 mm x 100 mm x 40 mm YES YES NO YES	100 mm x 100 mm x 40 mm YES YES NO		
Modes of operation Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	YES YES NO YES	YES YES NO		
Single beam processing Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	YES NO YES	YES NO		
Multibeam processing FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	YES NO YES	YES NO		
FULL-STAMP marking PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	NO YES	NO		
PIXEL-STAMP marking Dimensions and weight Laser head Laser head max dimensions	9	YES			
Dimensions and weight Laser head Laser head max dimensions	9		YES		
Laser head Laser head max dimensions	9	1030 mm			
Laser head max dimensions	9	1030 mm			
	9	1030 mm			
	\\/idth		1030 mm		
		431 mm	431 mm		
	Height	461 mm	361 mm		
Laser head max weight		140 kg max. without handling tool	120 kg max. without handling too		
Electrical cabinet					
Max dimensions		0,6 m x 0,6 m x 2 m			
Max weight		200 kg max.			
Cable length to laser head		5 m standard			
Safety and cretifications					
Laser safety class ²		4			
Safety level performance ³		d			
Safety contacts type		Dry contacts			
CE compliance		YE			
Utility & ambiant					
Electrical input	Voltage	230 VAC			
	Frequency	50-60 Hz			
	Supply	3 different lines 1			
	Max Power	6,5 kVA			
PLC communication		Ethernet, EthernetIP, ProfiNet			
Electrical outputs	Opto outputs (open collector)	Supply voltage : 5 V (not provided)			
'	7	Commuting level : 5 V			
		Sink curre	-		
	DAC	Max 15 mA			
		Software adjustable Max voltage (2.5 V / 5 V / 10 V) Max frequency 800 kHz			
Environment		Max frequer	ncy 800 kHz		
Environment Tomporature	Min storage range	40.4000			
_	Min storage range	10-40°C, non condensing			
Humidity	Min operation range	15-30°C, non condensing < 80%, non condensing			

 $^{^1}$ Depends on pulse duration and wavelength – contact us for more details capabilities 2 According to IEC 6025-1:2014 3 According to ISO 13849-1:2023





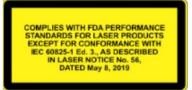
Laser head drawing with F167 telecentric lens











QiOVA follows a policy of continuous product improvement. Specifications are subject to change without notice.



